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PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Van Steenkiste et al.
Appl. No. : 09/744,465
Filed : April 16, 2001
For : SYSTEM AND A METHOD FOR
PLATING OF A CONDUCTIVE
PATTERN
Examiner : Brian L. Mutschler
Group Art Unit : 1753

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7/wm.
10/2/03

RESPONSE

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

In response to the Office Action dated May 22, 2003, Applicant respectfully requests that the Examiner enter the following amendments and consider the following remarks.

Amendments to the Specification begin on page 2 of this paper.

Amendments to the Claims are reflected in the listing of claims which begins on page 9 of this paper.

Amendments to the Drawings begin on page 11 of this paper.

Remarks/Arguments begin on page 12 of this paper.

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